



## GDZ6V2LP3Q - GDZ12LP3Q

## ULTRA-SMALL LEADLESS SURFACE MOUNT ZENER DIODE

### **Features**

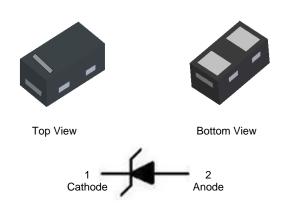
- Ultra-Small Leadless Surface Mount Package (0.6 x 0.3mm)
- Ultra-Low Profile Package (0.3mm)
- Ideally Suited for Automated Assembly Processes
- Low Leakage Current, Suitable for Battery-Powered Applications
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The GDZ6V2LP3Q GDZ12LP3Q are suitable for automotive applications requiring specific change control; these parts are AEC-Q101 qualified, PPAP capable, and manufactured in IATF16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

## **Mechanical Data**

- Package: X3-DFN0603-2
- Package Material: Molded Plastic, "Green" Molding Compound.
  UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Bar
- Terminals: Finish—Matte Tin over Copper Leadframe.
  Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.2 mg (Approximate)

#### X3-DFN0603-2



## **Ordering Information** (Note 4)

Part Number	Compliance	Package	Packing		
		rackage	Qty.	Carrier	
(Type Number)-7*	Automotive	X3-DFN0603-2	10,000	Tape & Reel	

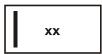
<sup>\*</sup>Add "-7" to the appropriate type number in the Electrical Characteristics Table. Example: 6.2V Zener = GDZ6V2LP3Q-7.

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

## **Marking Information**

Pin 1



xx = Product Type Marking Code (See Electrical Characteristics Table) Line Denotes Cathode Side



## **Thermal Characteristics**

Characteristic	Symbol Value		Unit	
Power Dissipation (Note 5)	$T_A = +25$ °C	$P_{D}$	250	mW
Thermal Resistance, Junction to Ambient Air (Note 5) T <sub>A</sub> = +25		$R_{\Theta JA}$	500	°C/W
Operating and Storage Temperature Range		$T_{J_i}T_{STG}$	-55 to +150	°C

## **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

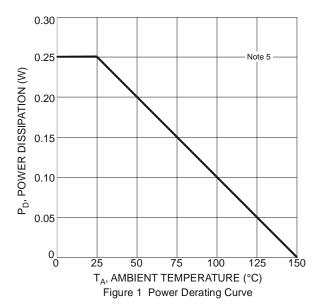
Туре	Marking	Zener Voltage Range (Note 6)				Reverse Current (Note 6)	
Number	Code		$V_Z @ I_{ZT}$		I <sub>ZT</sub>	$I_R$	@ <b>V</b> <sub>R</sub>
		Nom (V)	Min (V)	Max (V)	mA	Max (µA)	V
GDZ6V2LP3Q	KO	6.2	5.860	6.530	5	1.0	3.0
GDZ6V8LP3Q	KT	6.8	6.470	7.140	5	0.5	3.5
GDZ9V1LP3Q	JE	9.1	8.65	9.56	5	0.5	6.0
GDZ12LP3Q	JH	12	11.40	12.60	5	0.1	8.0

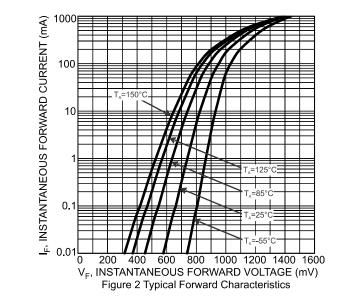
Notes:

<sup>5.</sup> Device mounted on FR-4 PCB with minimum recommended pad layout, as shown in Diodes Incorporated's Suggested Pad Layout document, which can be found on our website at http://www.diodes.com/products/packages.html.

<sup>6.</sup> Short duration pulse test used to minimize self-heating effect.







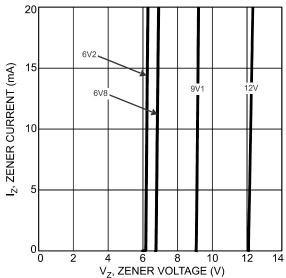


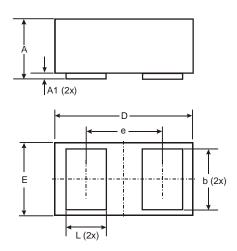
Figure 3 Typical Zener Breakdown Characteristics



# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### X3-DFN0603-2

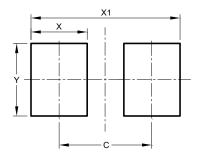


X3-DFN0603-2					
Dim	Min	Max	Тур		
Α	0.27	0.35	0.30		
A1	0.00	0.03	0.02		
b	0.19	0.29	0.24		
D	0.595	0.645	0.62		
Е	0.295	0.345	0.32		
е	-	-	0.355		
L	0.14	0.24	0.19		
All Dimensions in mm					

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### X3-DFN0603-2



Dimensions	Value (in mm)
С	0.380
Х	0.230
X1	0.610
Y	0.300



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